## **OKI** Semiconductor

This version: Jun. 1999

## ML9206-xx

 $5 \times 7$  Dot Character  $\times$  16-Digit Display Controller/Driver with Character RAM

#### **GENERAL DESCRIPTION**

The ML9206-xx is a dot matrix vacuum fluorescent display tube controller driver IC which displays characters, numerics and symbols.

Dot matrix vacuum fluorescent display tube drive signals are generated by serial data sent from a micro-controller. A display system is easily realized by internal ROM and RAM for character display.

The ML9206-xx has low power consumption since it is made by CMOS process technology. -01 is available as a general-purpose code.

Custom codes are provided on customer's request.

## **FEATURES**

• Logic power supply and vacuum fluorescent display tube drive power supply (V<sub>DD</sub>)

: 3.3 V±10% or 5.0 V±10%

• Fluorescent display tube drive power supply ( $V_{FL}$ ) : -20 to -60 V

• VFD driver output current

(VFD driver output can be connected directly to the fluorescent display tube. No pull-down resistor is required.)

- Segment driver (SEG1 to SEG35) : -6 mA (V<sub>FL</sub>=-60V) - Segment driver (AD1 and AD2) : -15 mA (V<sub>FL</sub>=-60V) - Grid driver (COM1 to COM16) : -30 mA (V<sub>FL</sub>=-60V)

• General output port output current

- Output driver (P1 and P2) :  $\pm 1$  mA ( $V_{DD}$ =3.3V $\pm 10%$ )  $\pm 2$  mA ( $V_{DD}$ =5.0V $\pm 10%$ )

Content of display

- CGROM 5×7 dots : 248 types (character data) - CGRAM 5×7 dots : 8 types (character data)

- ADRAM 16 (display digit) ×2 bits (symbol data)

- DCRAM 16 (display digit) ×8 bits (register for character data display)

- General output port 2 bits (static operation)

• Display control function

Display digit : 1 to 16 digitsDisplay duty (brightness adjustment) : 256 stages

- All lights ON/OFF

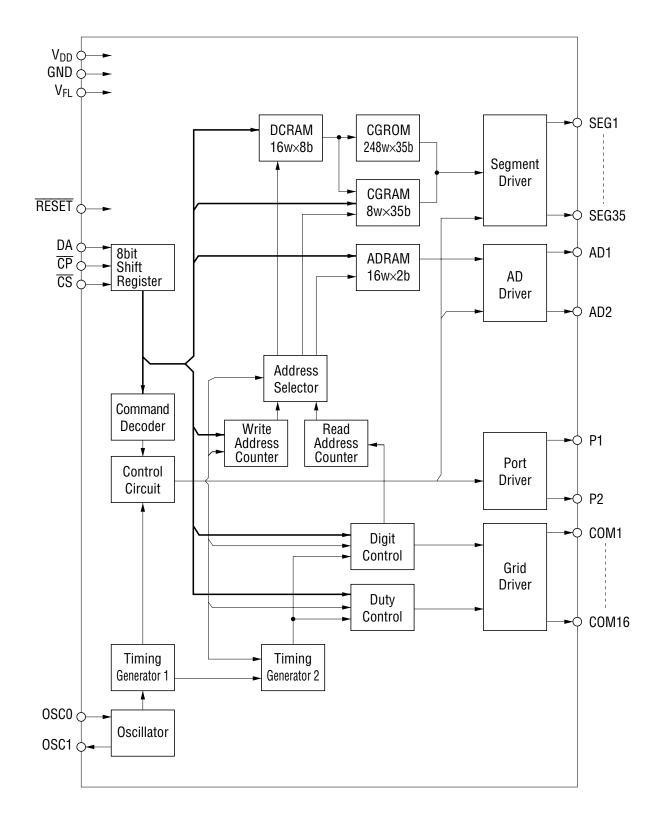
• 3 interfaces with microcontroller : DA,  $\overline{CS}$ ,  $\overline{CP}$  (4 interfaces when  $\overline{RESET}$  is added)

- 1-byte instruction execution (excluding data write and display duty set mode to RAM)
- Built-in oscillation circuit (external R and C)
- Package options:

64-pin plastic QFP (QFP64-P-1414-0.80-BK) (Product name : ML9206-xxGS-BK) 64-pin plastic SSOP (SSOP64-P-525-0.80-K) (Product name : ML9206-xxGS-K)

xx indicates the code number.

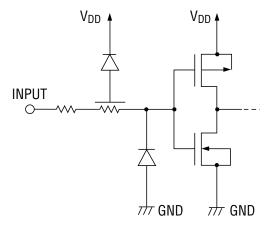
#### **BLOCK DIAGRAM**



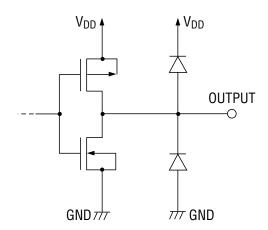
## INPUT AND OUTPUT CONFIGURATION

Schematic Diagrams of Logic Portion Input and Output Circuits

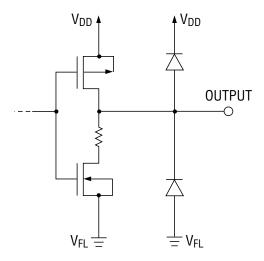
Input Pin



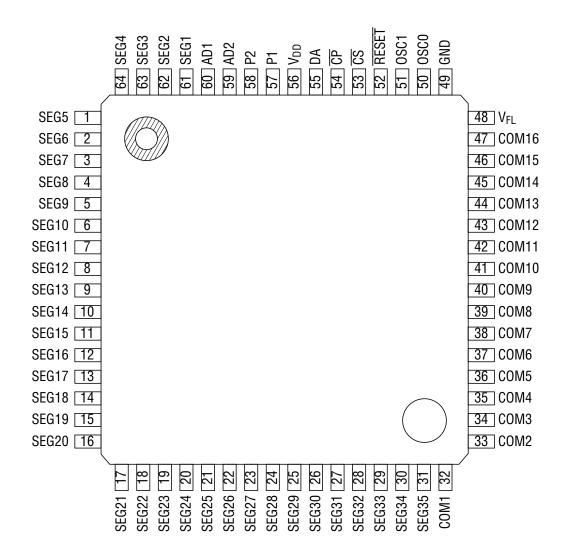
## Output Pin



Schematic Diagram of Driver Output Circuit

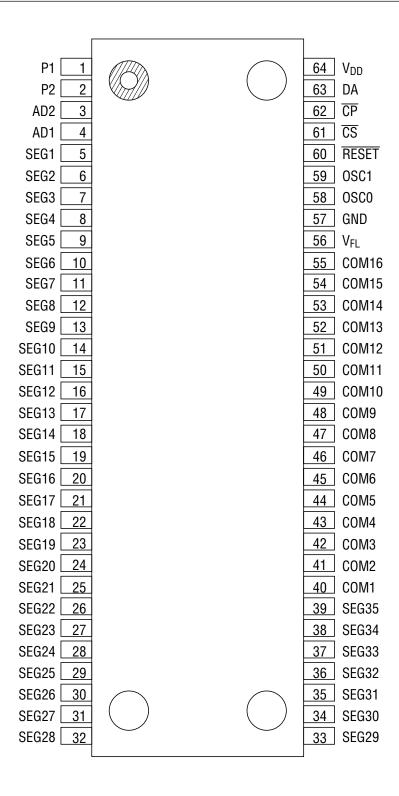


## **PIN CONFIGURATION (TOP VIEW)**



NC: No connection

64-Pin Plastic QFP



64-Pin Plastic SSOP

## **PIN DESCRIPTION**

P	in		_								
QFP	SSOP	Symbol	Туре	Connects to	Description						
1 to 31, 61 to 64	5 to 39	SEG1 to 35	0	Fluorescent tube anode electrode	Fluorescent display tube anode electrode drive output.  Directly connected to fluorescent display tube and a pull-down resistor is not necessary. I <sub>OH</sub> >–6 mA						
32 to 47	40 to 55	COM1 to 16	0	Fluorescent tube grid electrode	Fluorescent display tube grid electrode drive output.  Directly connected to fluorescent display tube and a pull-down resistor is not necessary. I <sub>OH</sub> >–30 mA						
59, 60	3, 4	AD1, AD2	0	Fluorescent tube anode electrode	Fluorescent display tube anode electrode drive output.  Directly connected to fluorescent display tube and a pull-dow resistor is not necessary. I <sub>OH</sub> >–15 mA						
57, 58	1, 2	P1, P2	0	LED drive control pins	General port output. Output of these pins in static operation, so these pins can drive the LED.						
56	64	$V_{DD}$		Power	V <sub>DD</sub> -GND are power supplies for internal logic.						
49	57	GND	_	supply	$V_{DD}$ - $V_{FL}$ are power supplies for driving fluorescent tubes. Apply $V_{FL}$ after $V_{DD}$ is applied.						
48	56	$V_{FL}$									
55	63	DA	I	Micro- controller	Serial data input (positive logic). Input from LSB.						
54	62	СP	I	Micro- controller	Shift clock input. Serial data is shifted on the rising edge of CP.						
53	61	CS	I	Micro- controller	Chip select input. Serial data transfer is disabled when $\overline{\text{CS}}$ pin is "H" level.						
52	60	RESET	I	Micro- controller or C <sub>2</sub> , R <sub>2</sub>	Reset input.  "Low" initializes all the functions. Initial status is as follows.  • Address of each RAM address "00"H  • Data of each RAM Content is undefined  • Display digit 16 digits  • brightness adjusment 0/256  • All lights ON or OFF OFF mode  • All outputs "Low" level  RESET (Circuit when R and C are connected externally)  See Application Circuit.						
50	58	OSC0	ı	0 0	External RC pin for RC oscillation. Connect R and C externally. The RC time constant depends on the $V_{DD}$ voltage used. Set the target oscillation frequency to 2 MHz.						
51	59	0801	0	C <sub>1</sub> , R <sub>1</sub>	OSCO (RC oscillation circuit)  See Application Circuit.						

## **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Conditi	on	Rating	Unit	
Supply Voltage (1)	$V_{DD}$	_		-0.3 to +6.5	V	
Supply Voltage (2)	V <sub>FL</sub>	_		-80 to V <sub>DD</sub> +0.3	V	
Input Voltage	V <sub>IN</sub>	_		-0.3 to V <sub>DD</sub> +0.3	V	
Dower Dissination	D	To> 0590	QFP	541		
Power Dissipation	P <sub>D</sub>	Ta≥25°C	SSOP	590	mW	
Storage Temperature	T <sub>STG</sub>	_		-55 to +150	°C	
	I <sub>01</sub>	COM1 to COM16		-40 to 0.0		
0	I <sub>02</sub>	AD1, AI	)2	-20 to 0.0		
Output Current	I <sub>03</sub>	SEG1 to S	SEG1 to SEG35 -10 to 0.0		mA	
	I <sub>04</sub>	P1, P2	2	-4.0 to +4.0		

## **RECOMMENDED OPERATING CONDITIONS-1**

When the power supply voltage is 5V (typ.)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage (1)	$V_{DD}$	_	4.5	5.0	5.5	V
Supply Voltage (2)	V <sub>FL</sub>	_	-60	_	-20	V
High Level Input Voltage	V <sub>IH</sub>	All input pins excluding OSCO pin	0.7V <sub>DD</sub>	_	_	V
Low Level Input Voltage	V <sub>IL</sub>	All input pins excluding OSCO pin	_	_	0.3V <sub>DD</sub>	V
CP Frequency	f <sub>C</sub>	_	_	_	2.0	MHz
Oscillation Frequency	fosc	$R_1=3.3k\Omega$ , $C_1=47pF$	1.5	2.0	2.5	MHz
Frame Frequency	f <sub>FR</sub>	DIGIT=1 to 16, $R_1$ =3.3k $\Omega$ , $C_1$ =47pF	183	244	305	Hz
Operating Temperature	T <sub>op</sub>	_	-40	_	+85	°C

## **RECOMMENDED OPERATING CONDITIONS-2**

When the power supply voltage is 3.3V (typ.)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage (1)	$V_{DD}$	_	3.0	3.3	3.6	V
Supply Voltage (2)	$V_{FL}$	_	-60		-20	V
High Level Input Voltage	V <sub>IH</sub>	All input pins excluding OSCO pin	$0.8V_{DD}$		_	V
Low Level Input Voltage	V <sub>IL</sub>	All input pins excluding OSCO pin	_	_	0.2V <sub>DD</sub>	V
CP Frequency	f <sub>C</sub>	_	_	_	2.0	MHz
Oscillation Frequency	fosc	$R_1=3.3k\Omega$ , $C_1=39pF$	1.5	2.0	2.5	MHz
Frame Frequency	f <sub>FR</sub>	DIGIT=1 to 16, $R_1$ =3.3 $k\Omega$ , $C_1$ =39 $pF$	183	244	305	Hz
Operating Temperature	T <sub>op</sub>	_	-40	_	+85	°C

## **ELECTRICAL CHARACTERISTICS**

#### **DC Characteristics-1**

(V<sub>DD</sub>=5.0V±10%, V<sub>FL</sub>=-60V, Ta=-40 to +85°C, unless otherwise specified)

Parameter	Symbol	Applied pin		Condition	Min.	Max.	Unit
High Level Input Voltage	$V_{IH}$	CS, CP, DA,		_	0.7V <sub>DD</sub>	_	V
Low Level Input Voltage	$V_{IL}$	CS, CP, DA, RESET		_		0.3V <sub>DD</sub>	V
High Level Input Current	I <sub>IH</sub>	CS, CP, DA, RESET		V <sub>IH</sub> =V <sub>DD</sub>	-1.0	+1.0	μА
Low Level Input Current	I <sub>IL</sub>	CS, CP, DA, RESET		V <sub>IL</sub> =0.0V		+1.0	μА
	V <sub>OH1</sub>	COM1 to 16	I <sub>OH1</sub> =–30mA		V <sub>DD</sub> -1.5	_	V
High Level Output Voltage	$V_{0H2}$	AD1, AD2		<sub>OH2</sub> =–15mA	V <sub>DD</sub> -1.5		V
	V <sub>OH3</sub>	SEG1 to 35		I <sub>OH3</sub> =–6mA	V <sub>DD</sub> -1.5		V
	$V_{OH4}$	P1, P2		I <sub>OH4</sub> =–2mA	V <sub>DD</sub> -1.0		V
Low Level Output Voltage	$V_{0L1}$	COM1 to 16 AD1, AD2 SEG1 to 35	<del>-</del>		_	V <sub>FL</sub> +1.0	V
	V <sub>0L2</sub>	P1, P2		I <sub>OL1</sub> =2mA	_	1.0	V
Cuanhi Currant	I <sub>DD1</sub>		f <sub>OSC</sub> =	Duty=240/256 Digit=1 to 16 All output lights ON	_	4	mA
Supply Current	I <sub>DD2</sub>	V <sub>DD</sub>	2MHz, no load	Duty=128/256 Digit=1 to 9 All output lights OFF	_	3	mA

## **DC Characteristics-2**

(VDD=3.3V±10%, VFL=-60V, Ta=-40 to +85°C, unless otherwise specified)

Parameter	Symbol	Applied pin		Condition	Min.	Max.	Unit
High Level Input Voltage	$V_{IH}$	CS, CP, DA,		_	0.8V <sub>DD</sub>	_	V
Low Level Input Voltage	$V_{IL}$	CS, CP, DA,		_		0.2V <sub>DD</sub>	V
High Level Input Current	I <sub>IH</sub>	CS, CP, DA,		V <sub>IH</sub> =V <sub>DD</sub>	-1.0	+1.0	μА
Low Level Input Current	I <sub>IL</sub>	CS, CP, DA,		V <sub>IL</sub> =0.0V	-1.0	+1.0	μА
	V <sub>OH1</sub>	COM1 to 16	I <sub>OH1</sub> =–30mA		<sub>OH1</sub> =–30mA V <sub>DD</sub> –1.5		V
High Level Output Voltage	$V_{0H2}$	AD1, AD2		<sub>OH2</sub> =–15mA	V <sub>DD</sub> -1.5	_	V
	$V_{OH3}$	SEG1 to 35		I <sub>OH3</sub> =–6mA	V <sub>DD</sub> -1.5	_	V
	$V_{OH4}$	P1, P2		I <sub>OH4</sub> =–1mA	V <sub>DD</sub> -1.0		V
Low Level Output Voltage	$V_{OL1}$	COM1 to 16 AD1, AD2 SEG1 to 35		_	_	V <sub>FL</sub> +1.0	V
	V <sub>0L2</sub>	P1, P2		I <sub>OL1</sub> =1mA	_	1.0	V
Overally Overant	I <sub>DD1</sub>		f <sub>OSC</sub> =	Duty=240/256 Digit=1 to 16 All output lights ON	_	3	mA
Supply Current	I <sub>DD2</sub>	- V <sub>DD</sub>	2MHz, no load	Duty=128/256 Digit=1 to 9 All output lights OFF	_	2	mA

#### **AC Characteristics-1**

 $(V_{DD}=5.0V\pm10\%, V_{FL}=-60V, Ta=-40 \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise specified})$ 

Parameter	Symbol	Cond	dition	Min.	Max.	Unit
CP Frequency	f <sub>C</sub>	_	_	_	2.0	MHz
CP Pulse Width	t <sub>CW</sub>	_	_	250	_	ns
DA Setup Time	t <sub>DS</sub>	_	250	_	ns	
DA Hold Time	t <sub>DH</sub>	_	_	250	_	ns
CS Setup Time	tcss	_	_	250	_	ns
CS Hold Time	t <sub>CSH</sub>	R <sub>1</sub> =3.3kΩ	., C <sub>1</sub> =47pF	16	_	μs
CS Wait Time	t <sub>CSW</sub>	_	250	_	ns	
Data Processing Time	t <sub>DOFF</sub>	R <sub>1</sub> =3.3kΩ	8	_	μs	
RESET Pulse Width	t <sub>WRES</sub>	When RESET si microcontrolle	250		ns	
RESET Time	t <sub>RSON</sub>	When RESET signal is input from microcontroller etc. externally		250		ns
		R <sub>2</sub> =1.0kΩ	, C <sub>2</sub> =0.1μF	_	200	μs
DA Wait Time	t <sub>RSOFF</sub>	_	_	250	_	ns
All Output Claw Data	t <sub>R</sub>	0 100mF	t <sub>R</sub> =20% to 80%	_	2.0	μS
All Output Slew Rate	t <sub>F</sub>	C <sub>I</sub> =100pF	t <sub>F</sub> =80% to 20%	_	2.0	μs
V <sub>DD</sub> Rise Time	t <sub>PRZ</sub>	When mount	ed in the unit		100	μs
V <sub>DD</sub> Off Time	t <sub>POF</sub>	When mounted in	the unit, V <sub>DD</sub> =0.0V	5.0		ms

## **AC Characteristics-2**

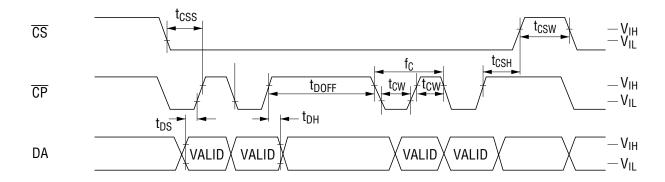
( $V_{DD}$ =3.3V±10%,  $V_{FL}$ =-60V, Ta=-40 to +85°C, unless otherwise specified)

Parameter	Symbol	Cond	dition	Min.	Max.	Unit
CP Frequency	f <sub>C</sub>	_	_	_	2.0	MHz
CP Pulse Width	t <sub>CW</sub>	_	_	250	_	ns
DA Setup Time	t <sub>DS</sub>	_	_	250	_	ns
DA Hold Time	t <sub>DH</sub>	_	_	250	_	ns
CS Setup Time	t <sub>CSS</sub>	_	_	250	_	ns
CS Hold Time	t <sub>CSH</sub>	R <sub>1</sub> =3.3kΩ	2, C <sub>1</sub> =39pF	16	_	μs
CS Wait Time	t <sub>CSW</sub>	_	250	_	ns	
Data Processing Time	t <sub>DOFF</sub>	R <sub>1</sub> =3.3kΩ	8	_	μs	
RESET Pulse Width	t <sub>WRES</sub>	When RESET si microcontrolle	250	_	ns	
RESET Time	t <sub>RSON</sub>	When RESET signal is input from microcontroller etc. externally		250	_	ns
		R <sub>2</sub> =1.0kΩ	, C <sub>2</sub> =0.1μF	_	200	μS
DA Wait Time	t <sub>RSOFF</sub>	_	_	250	_	ns
All Output Claw Data	t <sub>R</sub>	0 100-5	t <sub>R</sub> =20% to 80%	_	2.0	μs
All Output Slew Rate	t <sub>F</sub>	C <sub>I</sub> =100pF	t <sub>F</sub> =80% to 20%	_	2.0	μS
V <sub>DD</sub> Rise Time	t <sub>PRZ</sub>	When mount	ed in the unit	_	100	μS
V <sub>DD</sub> Off Time	t <sub>POF</sub>	When mounted in	the unit, V <sub>DD</sub> =0.0V	5.0	_	ms

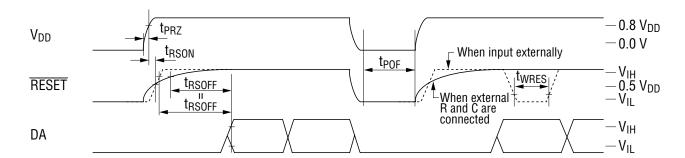
#### **TIMING DIAGRAM**

Symbol	V <sub>DD</sub> =3.3V±10%	V <sub>DD</sub> =5.0V±10%
V <sub>IH</sub>	0.8 V <sub>DD</sub>	0.7 V <sub>DD</sub>
$V_{IL}$	0.2 V <sub>DD</sub>	0.3 V <sub>DD</sub>

## • Data Timing



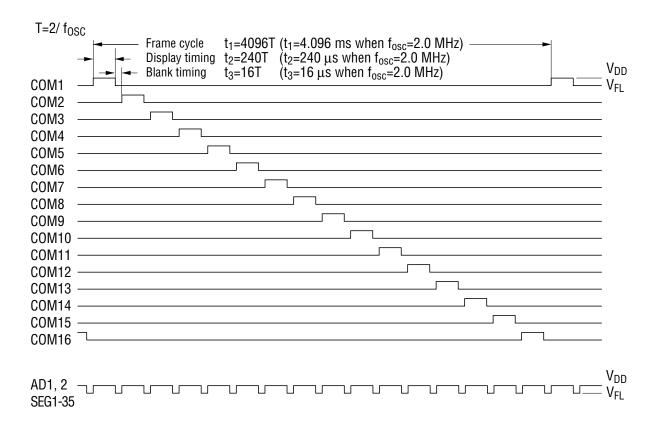
## • Reset Timing



## • Output Timing



#### • Digit Output Timing (for 16-digit display, at a duty of 240/256)



#### **FUNCTIONAL DESCRIPTION**

#### **Commands List**

	Command	LSB			1st	byte			MSB	LSB			2nd	byte			
	Command	В0	B1	B2	В3	B4	B5	В6	B7	В0	B1	B2	В3	В4	B5	В6	
1	DCRAM data write	X0	X1	X2	Х3	1	0	0	0	C0	C1	C2	C3	C4	C5	C6	Ī
										C0	C5	C10	C15	C20	C25	C30	
										C1	C6	C11	C16	C21	C26	C31	
2	CGRAM data write	X0	X1	X2	*	0	1	0	0	C2	<b>C</b> 7	C12	C17	C22	C27	C32	Ī
				C3	C8	C13	C18	C23	C28	C33							
										C4	C9	C14	C19	C24	C29	C34	Ī
3	ADRAM data write	Х0	X1	X2	Х3	1	1	0	0	CO	C1	*	*	*	*	*	Ī
4	General output port set	P1	P2	*	*	0	0	1	0				•				_
5	Display duty set	*	*	*	*	1	0	1	0	D0	D1	D2	D3	D4	D5	D6	Ī
6	Number of digits set	K0	K1	K2	*	0	1	1	0	*	· D	on't ca	are				_
7	All lights ON/OFF	L	Н	*	*	1	1	1	0	Xn : Address specification for		r each	1				
	Test mode									Cn		naract	•				
										_	_						

When data is written to RAM (DCRAM, CGRAM, ADRAM) continuously, addresses are internally incremented automatically.

Therefore it is not necessary to specify the 1st byte to write RAM data for the 2nd and later bytes.

Note: The test mode is used for inspection before shipment. It is not a user function.

each RAM

ion for each RAM Pn : General output port status specification

MSB

В7

C7

\*

D7

2nd byte

3rd byte

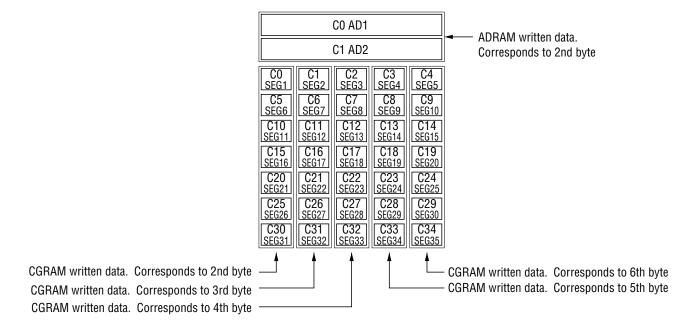
4th byte 5th byte

6th byte

Dn : Display duty specification Kn : Number of digits specification

H: All lights ON instruction : All lights OFF instruction

### Positional Relationship Between SEGn and ADn (one digit)



#### **Data Transfer Method and Command Write Method**

Display control command and data are written by an 8-bit serial transfer.

Write timing is shown in the figure below.

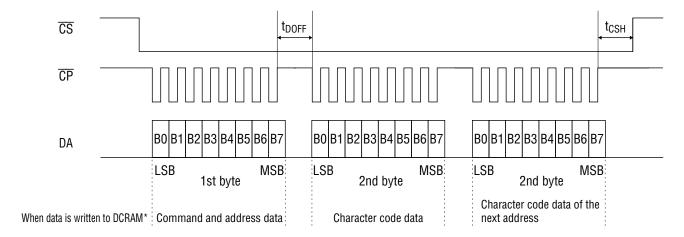
Setting the  $\overline{\text{CS}}$  pin to "Low" level enables a data transfer.

Data is 8 bits and is sequentially input into the DA pin from LSB (LSB first).

As shown in the figure below, data is read by the shift register at the rising edge of the shift clock, which is input into the  $\overline{CP}$  pin. If 8-bit data is input, internal load signals are automatically generated and data is written to each register and RAM.

Therefore it is not necessary to input load signals from the outside.

Setting the  $\overline{CS}$  pin to "High" disables data transfer. Data input from the point when the  $\overline{CS}$  pin changes from "High" to "Low" is recognized in 8-bit units.



\* When data is written to RAM (DCRAM, ADRAM, CGRAM) continuously, addresses are internally incremented automatically.

Therefore it is not necessary to specify the 1st byte to write RAM data for the 2nd and later bytes.

#### **Reset Function**

Reset is executed when the  $\overline{RESET}$  pin is set to "L", (when turning power on, for example) and initializes all functions.

Initial status is as follows.

• Address of each RAM ..... address "00"H

• Data of each RAM ...... All contents are undefined

• General output port ...... All general output ports go "Low"

• Display digit ...... 16 digits

• Brightness adjustment ...... 0/256

• All display lights ON or OFF ..... OFF mode

• Segment output ...... All segment outputs go "Low"

• AD output ...... All AD outputs go "Low"

Please set again according to "Setting Flowchart" after reset.

#### **Description of Commands and Functions**

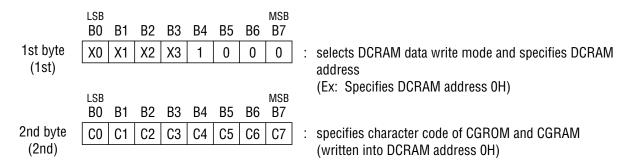
1. DCRAM data write (Specifies the address of DCRAM and writes the character code of CGROM and CGRAM.)

DCRAM (Data Control RAM) has a 4-bit address to store character code of CGROM and CGRAM.

The character code specified by DCRAM is converted to a 5×7 dot matrix character pattern via CGROM or CGRAM.

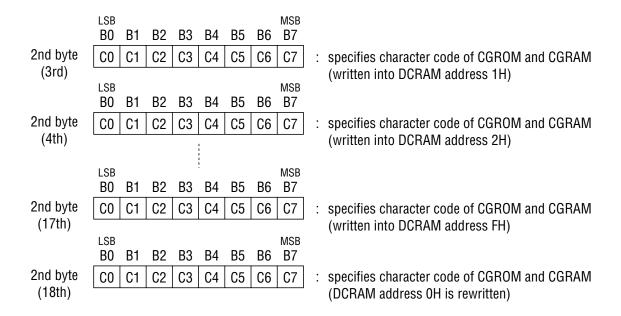
(The DCRAM can store 16 characters.)

#### [Command format]



To specify the character code of CGROM and CGRAM continuously to the next address, specify only character code as follows.

The addresses of DCRAM are automatically incremented. Specification of the 1st byte is unnecessary.



X0 (LSB) to X3 (MSB): DCRAM addresses (4 bits: 16 characters) C0 (LSB) to C7 (MSB): Character code of CGROM and CGRAM (8 bits: 256 characters)

#### [COM positions and set DCRAM addresses]

HEX	VA	V4	va	Х3	СОМ
ПЕХ	ΛU	ΛI	<b>^</b> 2	ΛJ	position
0	0	0	0	0	COM1
1	1	0	0	0	COM2
2	0	1	0	0	COM3
3	1	1	0	0	COM4
4	0	0	1	0	COM5
5	1	0	1	0	COM6
6	0	1	1	0	COM7
7	1	1	1	0	COM8
8	0	0	0	1	СОМ9
9	1	0	0	1	COM10
Α	0	1	0	1	COM11
В	1	1	0	1	COM12
С	0	0	1	1	COM13
D	1	0	1	1	COM14
Е	0	1	1	1	COM15
F	1	1	1	1	COM16

#### 2. CGRAM data write

(Specifies the addresses of CGRAM and writes character pattern data.)

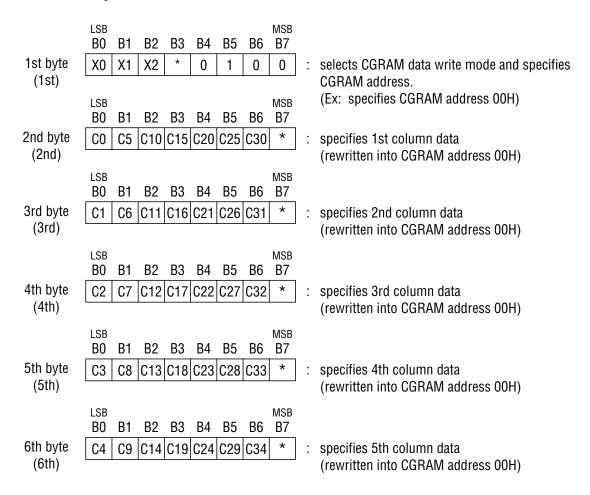
CGRAM (Character Generator RAM) has a 3-bit address to store 5×7 dot matrix character patterns.

A character pattern stored in CGRAM can be displayed by specifying the character code (address) by DCRAM.

The address of CGRAM is assigned to 00H to 07H. (All the other addresses are the CGROM addresses.)

(The CGRAM can store 8 types of character patterns.)

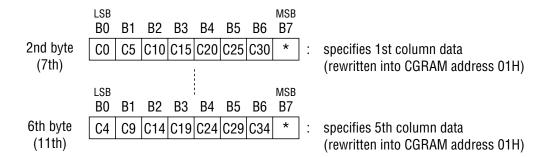
#### [Command format]



To specify character pattern data continuously to the next address, specify only character pattern data as follows.

The addresses of CGRAM are automatically incremented. Specification of the 1st byte is therefore unnecessary.

The 2nd to 6th byte (character pattern data) are regarded as one data item, so 300 ns is sufficient for  $t_{DOFF}$  time between bytes.



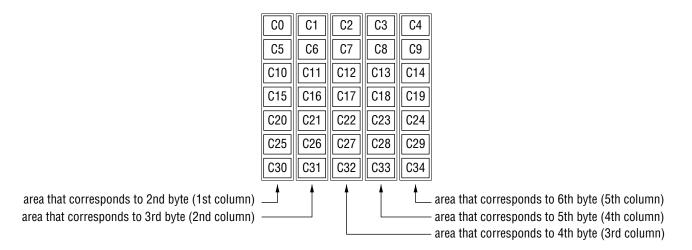
X0 (LSB) to X2 (MSB): CGRAM addresses (3 bits: 8 characters)
C0 (LSB) to C34 (MSB): Character pattern data (35 bits: 35 outputs per digit)
\*: Don't care

[CGROM addresses and set CGRAM addresses]

Refer to ROMCODE table

HEX	VO	V1	va	CGROM
ПЕХ	ΛU	ΛI	<b>\^</b> 2	address
00	0	0	0	RAM00(00000000B)
01	1	0	0	RAM01(00000001B)
02	0	1	0	RAM02(0000010B)
03	1	1	0	RAM03(00000011B)
04	0	0	1	RAM04(00000100B)
05	1	0	1	RAM05(00000101B)
06	0	1	1	RAM06(00000110B)
07	1	1	1	RAM07(00000111B)

Positional relationship between the output area of CGROM and that of CGRAM



Note: CGROM (Character Generator ROM) has an 8-bit address to generate 5×7 dot matrix character patterns.

CGRAM can store 248 types of character patterns.

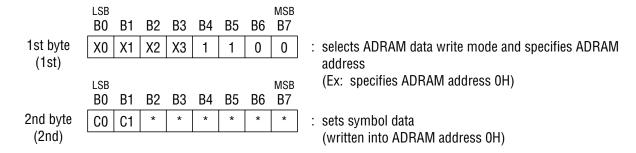
General-purpose code -01 is available (see ROM CODE list) and custom codes are provided on customer's request.

#### 3. ADRAM data write

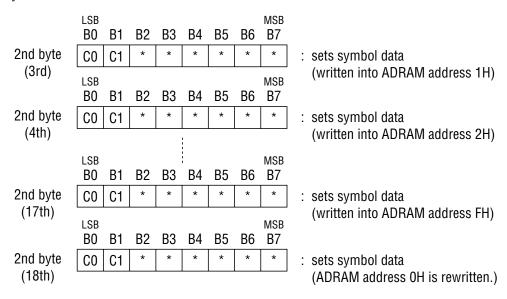
(specifies address of ADRAM and writes symbol data)

ADRAM (Additional Data RAM) has a 2-bit address to store symbol data. Symbol data specified by ADRAM is directly output without CGROM and CGRAM. (The ADRAM can store 2 types of symbol patterns for each digit.) The terminal to which the contents of ADRAM are output can be used as a cursor.

#### [Command format]



To specify symbol data continuously to the next address, specify only symbol data as follows. The address of ADRAM is automatically incremented. Specification of the 1st byte is therefore unnecessary.



X0 (LSB) to X3 (MSB): ADRAM addresses (4 bits: 16 characters)
C0 (LSB) to C1 (MSB): Symbol data (2 bits: 2-symbol data per digit)
\*: Don't care

ML9206-xx

#### [COM positions and ADRAM addresses]

**OKI** Semiconductor

HEX	X0	X1	X2	Х3	СОМ
					position
0	0	0	0	0	COM1
1	1	0	0	0	COM2
2	0	1	0	0	COM3
3	1	1	0	0	COM4
4	0	0	1	0	COM5
5	1	0	1	0	COM6
6	0	1	1	0	COM7
7	1	1	1	0	COM8
8	0	0	0	1	COM9
9	1	0	0	1	COM10
Α	0	1	0	1	COM11
В	1	1	0	1	COM12
С	0	0	1	1	COM13
D	1	0	1	1	COM14
E	0	1	1	1	COM15
F	1	1	1	1	COM16

## 4. General output port set (specifies the general output port status)

The general output port is an output for 2-bit static operation. It is used to control other I/O devices and turn on LED. (static operation) When at the "High" level, this output becomes the  $V_{DD}$  voltage, and when at the "Low" level, it becomes the ground potential. Therefore, the fluorescent display tube cannot be driven.

#### [Command format]

: selects a general output port and specifies the output status

P1, P2: general output port

\*: don't care

[Set data and set state of general output port]

P1	P2	Display state of general output port
0	0	Sets P1 and P2 to low
1	0	Sets P1 to high and P2 to low
0	1	Sets P1 to low and P2 to high
1	1	Sets P1 and P2 to high

(The state when power is applied or when RESET is input.)

## 5. Display duty set

(writes display duty value to duty cycle register)

Display duty adjusts brightness in 256 stages using 8-bit data. (maximum brightness=240/256) When power is turned on or when the  $\overline{\text{RESET}}$  signal is input, the duty cycle register value is "0". Always execute this instruction before turning the display on, then set a desired duty value.

#### [Command format]

	LSB B0	B1	B2	В3	B4	B5	В6	MSB B7	
1st byte	*	*	*	*	1	0	1	0	: selects display duty set mode and sets duty value
	LSB B0	B1	B2	В3	В4	В5	В6	MSB B7	
2nd byte	D0	D1	D2	D3	D4	D5	D6	D7	: Sets display duty value

D0 (LSB) to D7 (MSB): display duty data (8 bits: 256 stages)

\* : don't care

[Relation between setup data and controlled COM duty]

HEX	D0	D1	D2	D3	D4	D5	D6	D7	COM duty	
00	0	0	0	0	0	0	0	0	0/256	*The sta
01	1	0	0	0	0	0	0	0	1/256	on or w
02	0	1	0	0	0	0	0	0	2/256	
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1										
F7	1	1	1	0	1	1	1	1	239/256	
F8	0	0	0	1	1	1	1	1	240/256	$\exists$
1 1 1 1 1										No bri fixed b
FF	1	1	1	1	1	1	1	1	240/256	

\*The state when power is turned on or when RESET signal is input.

No brightness change du to fixed blank time (16/256)

#### 6. Number of digits set

(writes the number of display digits to the display digit register)

The number of digits set can display 1 to 16 digits using 4-bit data.

When power is turned on or when a RESET signal is input, the number of digit register value is "0". Always execute this instruction to change the number of digits before turning the dispaly on.

#### [Command format]

: selects the number of digit set mode and specifies the number of digit value

K0 (LSB) to K3 (MSB): number of digit data (4 bits: 16 digits)

\*: don't care

[Relation between setup data and controlled COM]

	HEX	K0	0 K1 K2 K3		Κĵ	Number of	HEX	K0	K1	K2	К3	Number of	
	ПЕХ	NU	KI	NZ	No	digits of COM	ПЕХ	NU	K I	N2	No	digits of COM	
-	0	0	0	0	0	COM1 to 16	8	0	0	0	1	COM1 to 8	
	1	1	0	0	0	COM1	9	1	0	0	1	COM1 to 9	
	2	0	1	0	0	COM1 to 2	Α	0	1	0	1	COM1 to 10	
	3	1	1	0	0	COM1 to 3	В	1	1	0	1	COM1 to 11	
	4	0	0	1	0	COM1 to 4	С	0	0	1	1	COM1 to 12	
	5	1	0	1	0	COM1 to 5	D	1	0	1	1	COM1 to 13	
	6	0	1	1	0	COM1 to 6	Е	0	1	1	1	COM1 to 14	
	7	1	1	1	0	COM1 to 7	F	1	1	1	1	COM1 to 15	

<sup>-</sup> \*The state when power is turned on or when  $\overline{\mathsf{RESET}}$  signal is input.

# 7. All display lights ON/OFF set (turns all dispaly lights ON or OFF)

All display lights ON is used primarily for display testing.

All display lights OFF is primarily used for display blink and to prevent malfunction when power is turned on.

This command cannot control the general output port.

#### [Command format]

> L: sets all lights OFF H: sets all lights ON

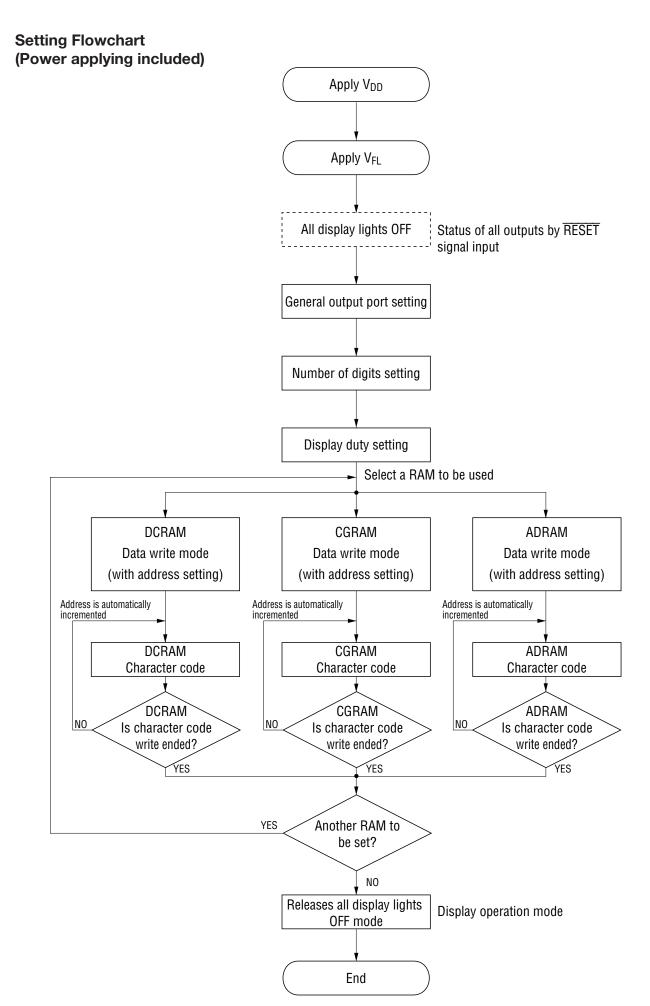
\*: Don't care

[Set data and display state of SEG and AD]

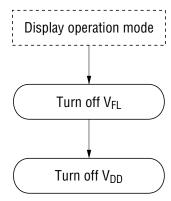
L	Н	Display state of SEG and AD	
0	0	Normal display	
1	0	Sets all outputs to Low	TI)
0	1	Sets all outputs to High	
1	1	Sets all outputs to High	一 (Al

(The state when power is applied or when  $\overline{\text{RESET}}$  is input.)

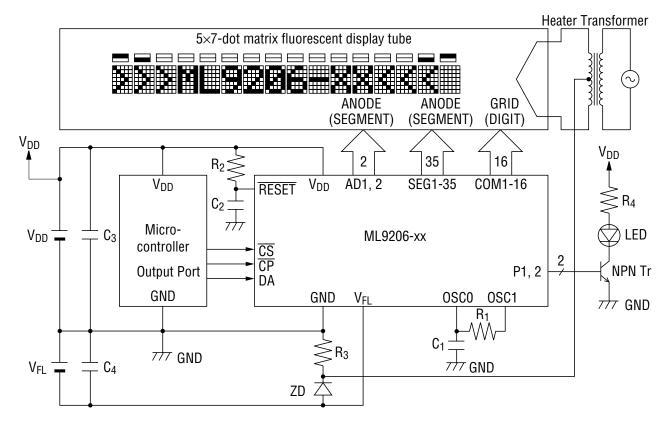
(All lights ON mode has priority.)



## **Power-off Flowchart**



#### **APPLICATION CIRCUIT**



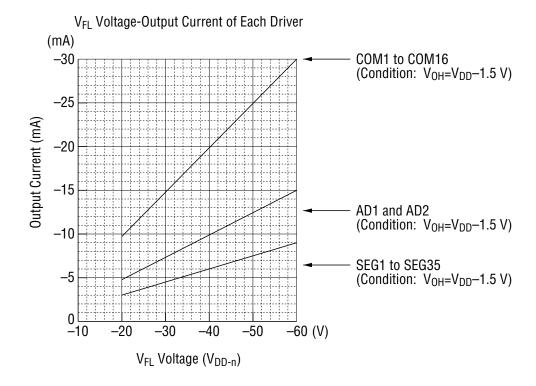
Notes: 1. The  $V_{DD}$  value depends on the power supply voltage of the microcontroller used. Adjust the values of the constants  $R_1$ ,  $R_2$ ,  $R_4$ ,  $C_1$ , and  $C_2$  to the power supply voltage used.

2. The  $V_{FL}$  value depends on the fluorescent display tube used. Adjust the values of the constants  $R_3$  and ZD to the power supply voltage used.

#### Reference data

The figure below shows the relationship between the  $V_{FL}$  voltage and the output current of each driver.

Take care that the total power consumption to be used does not exceed the power dissipation.



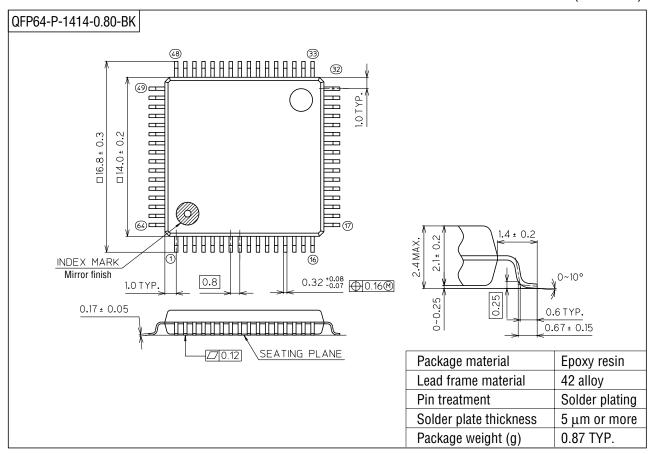
## ML9206-01 ROM Code

00000000B (00H) to 00000111B (07H) are the CGRAM addresses.

MSB																
LSB	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	RAM0															
0001	RAM1															
0010	RAM2															
0011	RAM3															
0100	RAM4															
0101	RAM5															
0110	RAM6															
0111	RAM7															
1000																
1001																
1010																
1011																
1100																
1101																
1110																
1111																

#### **PACKAGE DIMENSIONS**

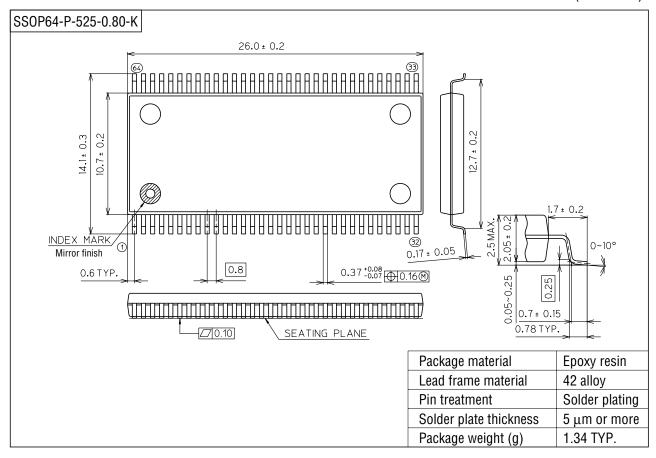
(Unit: mm)



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, TQFP, LQFP, SOJ, QFJ (PLCC), SHP, and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person on the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

(Unit: mm)



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- 2. The outline of action and examples for application circuits described herein have been chosen as an explanation for the standard action and performance of the product. When planning to use the product, please ensure that the external conditions are reflected in the actual circuit, assembly, and program designs.
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